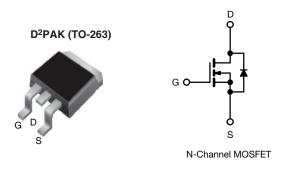
## SiHB22N60EF



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**Vishay Siliconix** 

# **EF Series Power MOSFET With Fast Body Diode**



PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650					
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.158				
Q <sub>g</sub> max. (nC)	96					
Q <sub>gs</sub> (nC)	9					
Q <sub>gd</sub> (nC)	21					
Configuration	Single					

### FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION					
Package	D <sup>2</sup> PAK (TO-263)				
Lead (Pb)-free and halogen-free	SiHB22N60EF-GE3				

<b>ABSOLUTE MAXIMUM RATINGS (T</b> <sub>C</sub>	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	V	
Gate-source voltage	V <sub>GS</sub>	± 30	v			
Continuous drain current ( $T_J = 150 \ ^\circ C$ )	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	19		
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		12	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	46		
Linear derating factor				1.4	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	144	mJ	
Maximum power dissipation			PD	179	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C		alı . / alt	70		
Reverse diode dv/dt d	•		dv/dt	50	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	For	10 s		260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 3.2 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt = 400$  A/µs, starting  $T_J = 25 \ ^\circ C$ 

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1 For technical questions, contact: <u>hvm@vishay.com</u>





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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.	TYP. MAX.			UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62						
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 0.7				°C/W		
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ ,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static	•					•	•	•
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.68	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	2.0	-	4.0	V
		$V_{GS} = \pm 20 V$			-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>		$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V		-	-	1	μA	
		$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			-	-		500
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A		-	0.158	0.182	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 11 A		-	5.8	-	S	
Dynamic								
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	1423	-	-	
Output capacitance	C <sub>oss</sub>			-	73	-		
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz		-	5	-	1
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>				-	48	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	240	-		
Total gate charge	Qg		I <sub>D</sub> = 11 A, V <sub>DS</sub> = 480		-	48	96	nC
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		A, V <sub>DS</sub> = 480 V	-	9	-	
Gate-drain charge	Q <sub>gd</sub>				-	21	-	
Turn-on delay time	t <sub>d(on)</sub>		•		-	15	30	
Rise time	t <sub>r</sub>	$V_{DD}$ = 480 V, $I_D$ = 11 A, $V_{GS}$ = 10 V, $R_g$ = 9.1 $\Omega$		-	21	42	- ns	
Turn-off delay time	t <sub>d(off)</sub>			-	58	87		
Fall time	t <sub>f</sub>	1			-	25		50
Gate input resistance	R <sub>g</sub>	f = 1	MHz, oper	n drain	0.3	0.6	1.2	Ω

Drain-Source Body Diode Characteristics								
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the	-	-	19	٨		
Pulsed diode forward current	I <sub>SM</sub>	p - n junction diode	-	-	46	A		
Diode forward voltage	V <sub>SD</sub>	$T_J = 25 \text{ °C}, I_S = 11 \text{ A}, V_{GS} = 0 \text{ V}$	-	-	1.2	V		
Reverse recovery time	t <sub>rr</sub>		-	113	226	ns		
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 11 A, di/dt = 100 A/μs, V <sub>B</sub> = 400 V	-	0.7	1.4	μC		
Reverse recovery current	I <sub>RRM</sub>		-	11	-	А		

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

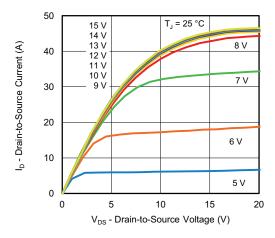


Fig. 1 - Typical Output Characteristics

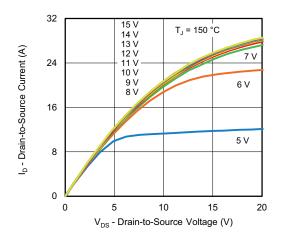


Fig. 2 - Typical Output Characteristics

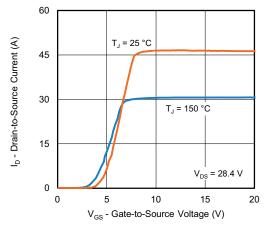


Fig. 3 - Typical Transfer Characteristics

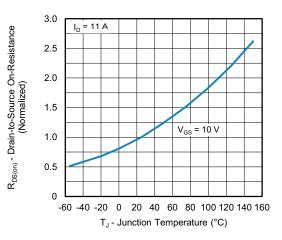


Fig. 4 - Normalized On-Resistance vs. Temperature

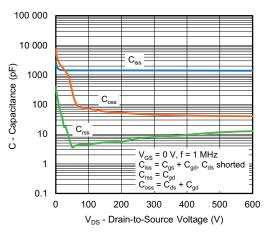


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

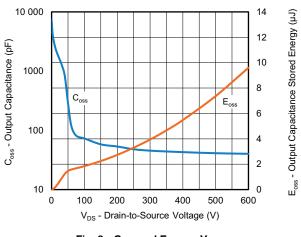


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

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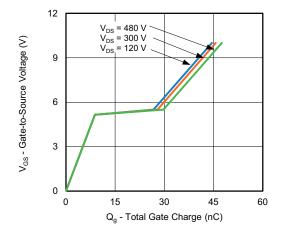


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

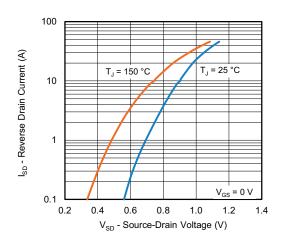
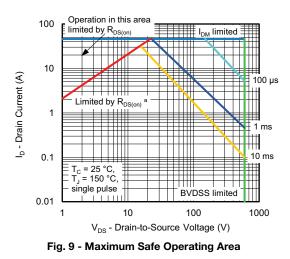


Fig. 8 - Typical Source-Drain Diode Forward Voltage



Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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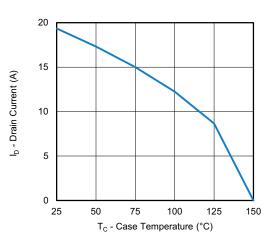


Fig. 10 - Maximum Drain Current vs. Case Temperature

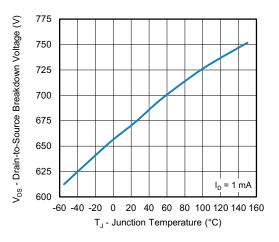


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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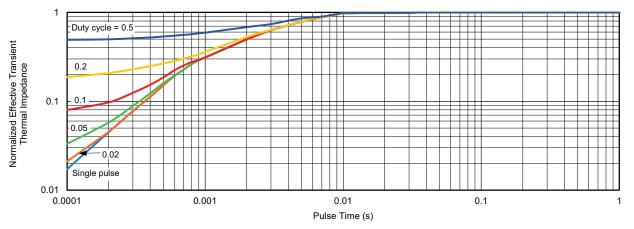


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

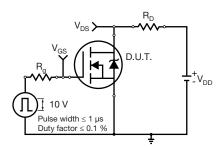


Fig. 13 - Switching Time Test Circuit

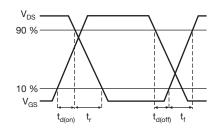


Fig. 14 - Switching Time Waveforms

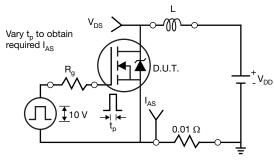


Fig. 15 - Unclamped Inductive Test Circuit

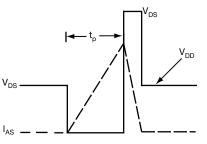


Fig. 16 - Unclamped Inductive Waveforms

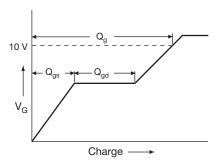


Fig. 17 - Basic Gate Charge Waveform

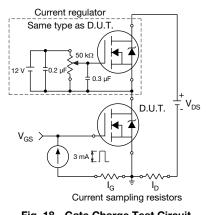
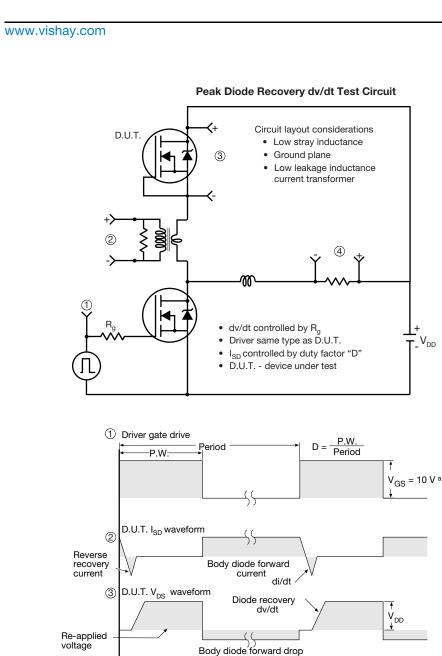


Fig. 18 - Gate Charge Test Circuit

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a.  $V_{GS} = 5$  V for logic level devices

Ripple ≤ 5 %

Inductor current

4

Note

Fig. 19 - For N-Channel

55

↑ I<sub>SD</sub>

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